



A Game Changer in Advanced IC Package Inspection

TeraView is pleased to introduce our fully automated integrated circuit (IC) package inspection system, the EOTPR 5000. Building on the success of the EOTPR 2000 which has an established track record in the industry for rapid fault isolation and manual inspection, the EOTPR 5000 is a fully automated advanced IC package inspection system that utilizes TeraView's proprietary EOTPR terahertz technology to detect weak or marginal interconnect quality in high volume manufacturing environments, which no other technology can detect today.

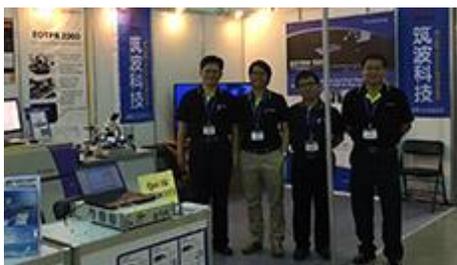
EOTPR 5000 launches at SEMICON West, USA



This year's SEMICON West event in San Francisco saw the launch of TeraView's new advanced IC package inspection system, the EOTPR 5000.

Dr Don Arnone, TeraView CEO, spoke to Philip Stoten of EMSNowTV to discuss what drove the technology and how it is currently being deployed.

TeraView at SEMICON Taiwan 2016



TeraView's Asia business agents ACE. Solution Ltd were on hand to promote the new EOTPR 5000 to all those who made it to Taipei for Semicon Taiwan.

A big thank you to the ACE team for a great show!

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Automotive Terahertz at IRMMW-THz 2016



TeraView were proud to sponsor this year's IRMMW-THz conference held in Copenhagen, Denmark.

Along with exhibiting at the event, TeraView's **Dr Philip Taday** gave a talk covering the recent use of TeraView's TeraCota system within the car manufacturing environment, with a paper titled:

'Extending Terahertz Paint Thickness Measurements To Advanced Industry-Standard Automotive Paint Structures'.

TeraView would like to thank all those involved with putting on the event again this year!